

**RECEIVED  
CENTRAL FAX CENTER**

FEB 09 2004

Docket No.: YOR920000578US1  
(PATENT)

**OFFICIAL****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Panayotis Andricacos, et al

Application No.: 09/760,884

Group Art Unit: 1741

Filed: January 17, 2001

Examiner: Smith Hicks

For: TUNGSTEN ENCAPSULATED COPPER  
INTERCONNECTIONS USING  
ELECTROPLATING

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This is in response to the Office Action dated October 9, 2003.

**Amendments to the Specification begin on page 2 of this paper;****Amendments to the Claims begin on page 3 of this paper;****Remarks and Arguments begin on page 5 of this paper.**